IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Allen et al.

Serial No.: To Be Assigned Filed: Concurrently Herewith

or: METHODS OF FABRICATING SILICON CARBIDE METAL-SEMICONDUCTOR

FIELD EFFECT TRANSISTORS

Date: November 12, 2003

Mail Stop PATENT APPLICATION Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Sir:

Attached is a list of documents on form PTO-1449. Items 1-56 listed on the PTO-1449 were cited in parent application Serial No. 09/567,717, filed May 10, 2000. Since the benefit of this application is claimed under 35 U.S.C. §120, no copies need to be furnished in accordance with 37 C.F.R. §1.98(d); however, copies will be furnished on request. It is requested that these documents be considered by the Examiner and officially made of record in accordance with the provisions of 37 C.F.R. §1.56 and Section 609 of the MPEP.

No fee is believed due. However, the Commissioner is hereby authorized to charge any deficiency or credit any overpayment to Deposit Account No. 50-0220.

Respectfully submitted,

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APPLICATION, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450

Rosa Lee Brinson

Attorney Docket Number: Serial No.: FORM PTO-1449 U.S. Department of Commerce Patent and Trademark Office 5308-127DV **TBA** LIST OF DOCUMENTS CITED BY APPLICANT (Use several sheets if necessary) Applicants: Allen, et al. Filing Date: Concurrently Herewith Group: U. S. PATENT DOCUMENTS

Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date if Appropriate
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	2.	6,316,793	11/2001	Sheppard et al.	257	103	,
	3.	6,218,680	04/2002	Carter, Jr. et al.	257	77	
	4.	6,121,633	09/2000	Singh et al.	257	77	
	5.	6,107,649	08/2000	Zhao	257	138	
	6.	5,972,801	10/26/99	Lipkin, et al	438	770	
	7.	5,925,895	07/20/99	Sriram, et al.	257	77	
	8.	5,900,648	05/04/99	Harris et al.	257 .	77	
	9.	5,895,939	4/20/99	Ueno	254	279	
	10.	5,719,409	02/1998	Singh et al.	257	77	
	11.	5,686,737	11/1997	Allen	257	77	
	12.	5,510,630	04/1996	Agarwaa et al.	257	77	
•	13.	5,399,883	3/21/95	Baliga	257	57	
,	14.	5,396,085	03/07/95	Baliga	257	77	
	15.	5,229,625	04/20/93	Suzuki et al.	257	77	
	16.	5,270,554	12/14/93	Palmour	257	77	
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	18.	4,947,218	08/07/90	Edmond, et al.	357	13	
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sh.	41.	"First Silicon Carbide Microwave Power Products are Introduced," Applied Microwave & Wireless.						
	42.	"SiC MESFET Drives PCS Base Stations," Wireless Systems Design. (October 1999).						
	43.	Allen, et al. "Silicon Carbide MESFET's with 2 w/mm and 50% P.A.E. at 1.8 GHz," MTT Conference. 1996.						
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	45.	Browne, Jack. "Top Products of 1999," Microwaves &RF. (December 1999).						
	46.	Browne, SiC MESFET Delivers 10-W Power at 2 GHZ, Microwaves & RF. October 1999, pp. 138-139						
	47.	Carter et al., Silicon Carbide and Related Materials, 1999, Part 2, Materials Science Forum, Vols. 338-342, pp. 1247-1266 (2000).						
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	51.	Symposium. Hilton et al., Surface Induced Instabilities in 4H-SiC Microwave MESFETs, Materials Science Forum, Vols. 338-342, 2000, pp. 1251-1254						
	52.	Jonsson et al., Physical Simulations on the Operations of 4H-SiC Microwave Power Transistors, Materials Science Forum, Vols. 338-342, 2000, pp. 1263-1266						
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		No. 9, (Sept. 1987).						
	54.	Kong, et al. "Temperature dependence of the current-voltage characteristics of metal-semiconductor field-effect transistors in n -type β -SiC grown via chemical vapor deposition," <i>Applied Physics Letters</i> . Vol. 5i, No. 5, (10 Aug. 1987).						
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	56.	Soc. Symp. Proc., Vol. 640, 2001, pp. H2.4.1-H2.4.6 Ma, et al., High Efficiency LDMOS Power FET for Low Voltage Wireless Communications, 1996 IEEE.						
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